

11-25-1998

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Makoto NOGAWA

Additional name(s) of conveying party(ies) attached? _ Yes ☒ No3. Nature of conveyance: **MRTD 11-16-98**☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: September 28, 1998

2. Name and Address of receiving party(ies):

Name: KOMATSU LTD.

Internal Address:

Street Address: 3-6, Akasaka 2-chome
Minato-ku

City: Tokyo

State: JAPAN ZIP: 107

Additional name(s) & address(es) attached? _ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

08/849,178

B. Patent No.(s)

Additional numbers attached? _ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SIDLEY & AUSTIN

Internal Address: Attn: James W. Williams

Street Address: 717 N. Harwood
Suite 3400

City: Dallas State: TX ZIP: 75201-6507

6. Total Number of applications and patents involved: 17. Total fee (37 CFR 3.41).....\$ 40.00☒ Enclosed☐ Authorized to be charged to deposit account

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*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Daren C. Davis

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Signature

November 12, 1998

Date

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FC:501

PATENT

REEL: 9595 FRAME: 0803

ASSIGNMENT

In consideration of the sum of One Dollar (U.S. \$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

Satoshi FUJIMOTO and Makoto NOGAWA

hereby sells, assigns and transfers to KOMATSU LTD., a corporation duly organized under the laws of Japan, and having a place of business at 3-6, Akasaka 2-chome, Minato-ku, Tokyo 107 Japan, (hereinafter called Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled

INJECTION COMPRESSION MOLDING METHOD AND APPARATUS

which application was filed on May 28, 1997 and accorded serial number 08/849,178; including said application and any and all divisions, continuations, and substitutes thereof and any and all United States Letters Patents which may be granted therefor and any and all extensions, reissues, renewals or reexaminations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Signed at _____, JAPAN, the _____ day
of _____, 1998.

Satoshi FUJIMOTO

Signed at Hirakata - shi, JAPAN, the 28 day
of September, 1998.

Makoto Nogawa
Makoto NOGAWA